



Mars2020 Entry, Descent, and Landing Instrumentation 2 (MEDLI2) Do No Harm Test Series

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Greg Swanson – AMA Incorporated @ NASA ARC Jose Santos – Sierra Lobo @ NASA ARC Todd White – NASA ARC Walt Bruce, Chris Kuhl, Henry Wright – NASA LaRC



MEDLI2 Instrumentation Summary



MEDLI2 complements and extends the measurements of MEDLI on the Mars Science Laboratory (MSL) with additional heatshield observation locations, inclusion of supersonic aerodynamics, and backshell aerothermal and pressure observations.







Accommodation of MEDLI2 sensors requires modifications to the Mars 2020 TPS

> DNH testing ensured:

- TPS Performance degradation due to the sensor integration is minimized (or prevented)
- TPS Performance changes (if any) are characterized
- TPS failures are prevented

> MEDLI2 DNH Testing included:

- Environmental testing (vibe, shock, t/vac) of the DNH panels
- Bounding aerothermal (arc jet) testing of the DNH panels
- Associated pre- and post-test inspections & associated analysis

> MEDLI2 DNH Testing covered only new backshell instrumentation (SLA-561V)

- MEDLI2 relied on earlier MEDLI/MSL testing as the basis of heatshield (PICA) DNH efforts
- MEDLI2 will perform arc jet and environmental testing for the heatshield components later in the project life cycle as part of the normal flight lot TPS accommodation certification
- MEDLI2 DNH Testing does not include the environmental testing of the backshell mounted pressure transducer –this will be performed separately





- Four 12" x 12" SLA-561V Panel with Substructure
- Installed additional Thermocouples (TCs) at the bondline and backface after environmental testing for arc jet testing
- The four pressure port holes were located in specific proximities to the SLA-561V flexcore to examine the effect of the flexcore on the port hole (if any)
- The MEADS port plug was a mitigation concept if any issues were seen with port hole proximity to the flexcore



Tabs For Arc Jet Mounting

Threaded Inserts for Mounting During Testing



*All pressure ports are blind holes in the TPS, no active pressure measurements are present



Do No Harm Test Series Sequence





>MEDLI2's Overall DNH Approach

- Build / procure flight-like backshell instrumentation
- Have Lockheed Martin develop and demonstrate backshell sensor integration on four flight-like TPS/substructure panels
- Expose the integrated panels to Mars 2020 qualification level environments (loads and durations)
- Expose the environmentally tested panels to worst-case simulated aeroheating in an arc jet
- Inspect and document the panels between each of the above tests
- One of four panels used as a control for the environmental testing





The acceleration spectral density (ASD) test levels for random vibration testing are taken from the Mars2020 Environmental Requirements Document and are detailed in "Qualification/Protoflight level" column below.

Vibrational Loads are derived from the expected Atlas V launch environment



- Test in all 3-axes, two minutes per axis
- The ASD shall be within ±3 dB over the 20-2000 Hz
- Overall spectrum level shall be within ±1 dB of the specified rms level



Random Vibration Test Setup





Z-Axis Setup

X-, Y-Axis Setup



Shock Test Specifications



Shock loads are derived from the expected load of the ballast mass jettison event since many of the sensors are in close proximity



- Tolerance bands of +/- 6 dB to 3000 Hz, and +9/-6 dB above 3000 Hz
- At least 50% of the maximum spectrum values shall exceed the nominal
- Shock pulse should decay to less than 10% of its peak value within 20ms
- All 3-axes (x, y, and z) must be shocked, two shock per axis



Shock Test Setup





Thermal loads are derived from the expected backshell worst case environments during the cruise phase

Condition	Phase	Target Temperature	Pressure	Dwell Time
No.		(°C)	(torr)	(minutes)
1	Check up	T _{room} +5 °C /- 0 °C	Ambient	60
2	Worst hot	+77 +/- 2 °C	<10 ⁻⁵ Torr	180
3	Worst cold	-140 +/- 2 °C	<10 ⁻⁵ Torr	180
4	Worst hot	+77 +/- 2 °C	<10 ⁻⁵ Torr	180
5	Worst cold	-140 +/- 2 °C	<10 ⁻⁵ Torr	180
6	Worst hot	+77 +/- 2 °C	<10 ⁻⁵ Torr	180
7	Worst cold	-140 +/- 2 °C	<10 ⁻⁵ Torr	180
8	Check up	T _{room} +5 °C /- 0 °C	<10 ⁻⁵ Torr	60
9	Back fill	T _{room} +5 °C /- 0 °C	Ambient	-

- Test to be performed as specified in the table above
- Temperature ramp rate must be less than or equal to 5°C per minute when transitioning between test conditions
- Dwell time does not begin until all conditions are correct

Thermal Vacuum Test Setup

- DNH PTF arc jet test was performed Sept 2016 after completion of all the environmental testing
- Arc Jet Test Objectives:
 - 1. Demonstrate that the presence of the pressure ports through the TPS do not result in unacceptable degradation of the surrounding TPS.
 - 2. Demonstrate that the presence of the pressure ports through the TPS do not results in TPS to backshell structure bond line exceeding maximum allowable temperatures
 - 3. Demonstrate that the presence of the MISPs in the TPS do not result in unacceptable degradation of the surrounding TPS.
 - 4. Demonstrate that the presence of the MISPs in the TPS do not result in the TPS to backshell structure bondline exceeding their specified maximum allowable temperatures
 - 5. Demonstrate that the presence of the heat flux sensors in the backshell TPS do not result in unacceptable degradation of the surrounding TPS.
 - 6. Demonstrate that the presence of the heat flux sensors in the backshell TPS do not result in the TPS to backshell structure bondline exceeding their specified maximum allowable temperatures

Arc Jet Test Matrix

Run, Panel	Environmental Test			Target Arc Jet Conditions			
	Shock	Vibe	TVac	LN ₂ Cold Soak	Heat Flux (W/cm ²)	Exposure (sec)	Pressure (kPa)
Run 1 Panel 2	Y	Y	Y	Ν	8.2	110	Best Effort
Run 2 Panel 3	Y	Y	Y	Y	21.0	43	0.86
Run 3 Panel 1	Y	Y	Y	Y	21.0	43	0.86
Run 4 Panel 4	Ν	Ν	Ν	Ν	8.2	110	Best Effort

- Two calibration runs (180 & 181) on August 30-31.
- Model runs were performed on September 6-8.

- MEDLI2 met targeted aerothermal test conditions (heatflux, heatload, pressure & shear) in the Ames Panel Test Facility (PTF)
- Inspection and analysis of test articles confirmed that MISP, pressure ports, and Heat Flux sensors did not cause degradation of the surrounding TPS
 - Laser scans show surface features at the sensor locations are all much less than 0.050"
 - All IML and bondline temperatures stayed below 150°C
- No observable difference between panels (Panels 1-3) and the control (Panel 4)

Do No Harm Test Data Products

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-0.040 0.80 0.900

1.100 1.200 1.300 Flow Direction (inches) _тс,5

_тс_к6

-TC

3000

Test Series Summary

- MEDLI2 project built and procured flight-like instrumentation
 - Ames built MISP, and Heat Flux sensors were procured from outside vendor
- Lockheed Martin developed and exercised integration procedures on four test panels
- MEDLI2 successfully tested 3 of 4 panels in environmental tests (vibe, shock, t/vac)
 - New mechanical shock test approach was used to efficiently test all 3-axes with one shock event
- All 4 models successfully underwent arc jet testing
 - Two panels were thermally shock using a LN₂ bath prior to arc jet testing
- Overall panel and instrument Do No Harm performance was excellent
 - Pressure transducer port holes appear to be unaffected by proximity to SLA-561V cell walls
 - Laser scans show surface features at the sensor locations are all much less than 0.050"
 - All IML and bondline temperatures stayed below 150°C
- In addition to Do No Harm, science data was collected from sensors allowing investigation past Do No Harm requirements

BACKUP

MEDLI vs. MEDLI2 Science Payload

MEDLI on MSL (2012)

7 Pressure Transducers Hypersonic

Heatshield

MEDLI2 on Mars2020

1 Pressure Transducer

6 Instrumented Plugs

1 Plugs has 2 TCs

3 Heat Flux Sensors

2 Total & 1 Radiative

5 Plugs have 1 TC

PL P/N:10251633-1 N: P-MISP-091908-0

7 Instrumented Plugs

- 4 TCs
- 1 Isotherm Sensor

- **11 Instrumented Plugs**
- 3 Plugs have 3 TCs
- 8 Plugs have 1 TC

Heatshield

- 7 Pressure Transducers
- 6 Supersonic
- 1 Hypersonic

Sensor Support **Electronics Box**

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